

TSG10N120CN

N-Channel IGBT with FRD.

Pb RoHS

TO-3P

Pin Definition:

- Gate
 Collector
- 3. Emitter

PRODUCT SUMMARY

V _{CES} (V)	V _{GES} (V)	I _C (A)
1200	±30	10.5

General Description

The TSG10N120CN using proprietary trench design and advanced NPT technology, the 1200V NPT IGBT offers superior conduction and switching performances, high avalanche ruggedness and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating, microwave oven, etc.

Features

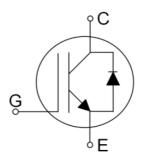
- 1200V NPT Trench Technology
- High Speed Switching
- Low Saturation Voltage

Ordering Information

Part No.	Package	Packing		
TSG10N120CN C0G	TO-3P	30pcs / Tube		

Note: "G" denote for Halogen Free Product

Block Diagram



NPT Trench IGBT

Absolute Maximum Rating (T_A=25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit
Collector-Emitter Voltage		V _{CES}	1200	V
Gate-Emitter Voltage		V_{GES}	±30	V
Continuous Current	T _C =25°C		21	А
	T _C =100°C	I _C	10.5	А
Pulsed Collector Current *		I _{CM}	42	А
Diode Forward Current (T _C =100°C)		l _F	8	А
Diode Pulse Forward Current		I _{FM}	40	А
Max Power Dissipation	T _C =25°C	P_{D}	125	W
Operating Junction Temperature		T _J	-55 to +150	°C
Storage Temperature Range		T _{STG}	-55 to +150	°C

^{*} Repetitive rating: Pulse width limited by max. junction temperature



TSG10N120CN



Thermal Performance

Parameter		Symbol	Limit	Unit
The annual Decistors on the state of the Control	IGBT	DO.	1	°C/W
Thermal Resistance - Junction to Case	DIODE	RΘ _{JC}	2	
Thermal Resistance - Junction to Ambient		$R\Theta_{JA}$	40	

Electrical Specifications (Tc=25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Static						
Collector-Emitter Leakage Current	$V_{CE} = 1200V, V_{GE} = 0V$	I _{CES}			1	mA
Gate-to-Emitter Leakage Current	$V_{GE} = \pm 30 V, V_{CE} = 0 V$	I _{GES}			±500	nA
Gate Threshold Voltage	$V_{GE} = V_{CE}, I_{C} = 250uA$	$V_{GE(TH)}$	3		7	V
Collector-Emitter Saturation Voltage	$V_{GE} = 15V, I_{C} = 5A$	$V_{CE(SAT)}$		2.3	2.7	V
Dynamic				_		
Input Capacitance	.,	C _{IES}		6800	10880	
Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$	C _{OES}		65		pF
Reverse Transfer Capacitance	f = 1.0MHz	C _{RES}		10		
Switching						
Turn-On Delay Time	V_{CC} = 960V, I_{C} = 5A, R_{G} = 22 Ω , V_{GE} = 15V Inductive Load, T_{J} =25 $^{\circ}$ C	t _{d(on)}		30		
Rise Time		t _r		13		0
Turn-Off Delay Time		t _{d(off)}		130		nS
Fall Time		t _f		230	460	
Turn-On Switching Loss		E _{on}		0.3		
Turn-Off Switching Loss		E _{off}		0.5		mJ
Total Gate Charge)/ 000\/ I 5A	Q_g		33	53	
Gate-Emitter Charge	$V_{CC} = 600V, I_C = 5A,$ $V_{GE} = 15V$	Q_ge		6.5		nC
Gate-Collector Charge		Q_{gc}		17.5		

Electrical Specifications of the DIODE (Tc=25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Forward Voltage	$I_F = 8A$,	V_{F}		2.5	3.2	V
Reverse Recovery Time	I _F = 8A, di/dt=100A/us	t _{rr}		70		ns
Reverse Recovery Charge		Q _{rr}		170		nC

2/7 Version: Preliminary

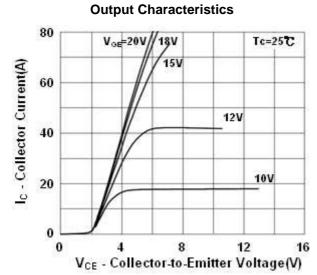


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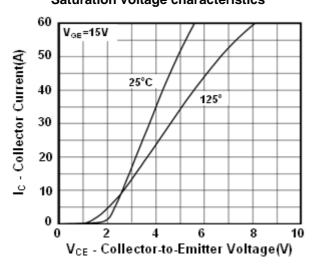
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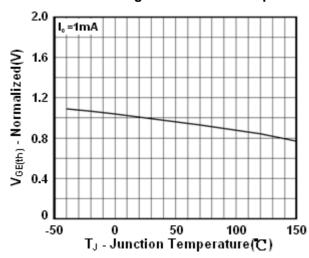
Electrical Characteristics Curve (Tc = 25°C, unless otherwise noted)



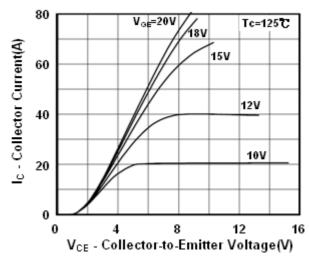
Saturation voltage characteristics



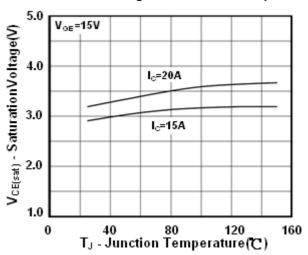
Gate Threshold Voltage vs. Junction Temperature



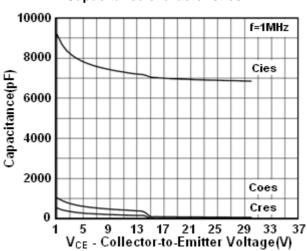
Output Characteristics



Collector-Emitter Voltage vs. Junction Temperature



Capacitance characteristics



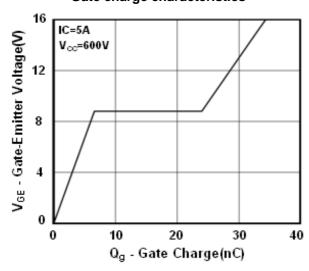


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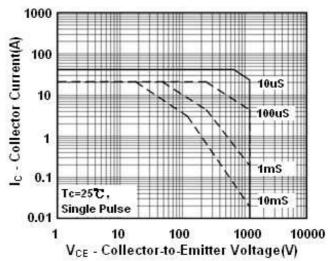
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Electrical Characteristics Curve (Tc = 25°C, unless otherwise noted)

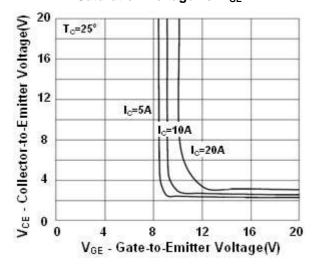
Gate charge characteristics



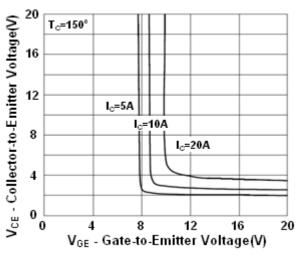
SOA Characteristics



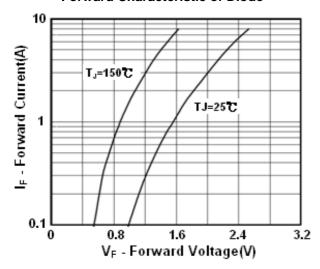
Saturation Voltage vs. V_{GE}



Saturation Voltage vs. V_{GE}



Forward Characteristic of Diode





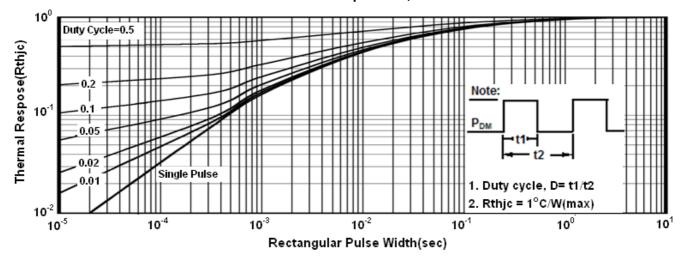
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Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

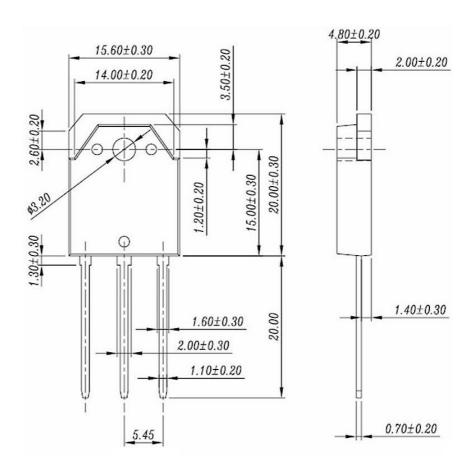


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TO-3P Mechanical Drawing



Unit: Millimeters



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7/7 Version: Preliminary